



# Product Change Notification

**Change Notification #:** 117464 - 00  
**Change Title:** Select Intel® SSD DC D4512 Series, PCN 117464-00, Label, Label Update  
**Date of Publication:** March 9, 2020

**Key Characteristics of the Change:**  
 Label

**Forecasted Key Milestones:**

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	April 1, 2020
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**Description of Change to the Customer:**

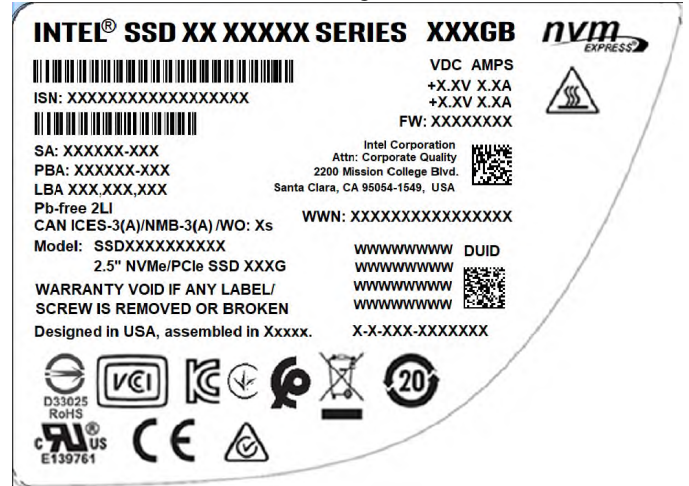
The Intel® SSD DC D4512 Series SKUs listed in the Products Affected Table below will have the following change.

Remove PCIE Express logo from label.

Current Image



New Image



## Customer Impact of Change and Recommended Action:

There is no change to the form, fit, or function of the product. The change is only to the labels used in packaging.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC D4512 Series (1.9TB, 2.5in PCIe 3.1 2x2, 3D2, TLC) Generic Single Pack	SSDPD2KS019T801	976881

## PCN Revision History:

**Date of Revision:**

March 9, 2020

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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